

Low Power Mono Audio CODEC

FEATURES

System

- High performance and low power multibit delta-sigma audio ADC and DAC
- I²S/PCM master or slave serial data port
- 256/384Fs, USB 12/24 MHz and other non standard audio system clocks
- I²C interface

ADC

- 24-bit, 8 to 96 kHz sampling frequency
- 100 dB signal to noise ratio, -93 dB THD+N
- One pair of analog input with differential input option
- Low noise pre-amplifier
- Noise reduction filters
- Auto level control (ALC) and noise gate
- Support analog and digital microphone

DAC

- 24-bit, 8 to 96 kHz sampling frequency
- 110 dB signal to noise ratio, -80 dB THD+N
- One pair of analog output with headphone driver and differential output option
- Dynamic range compression
- Pop and click noise suppression

Low Power

- 1.8V to 3.3V operation
- 14 mW playback and record
- Low standby current

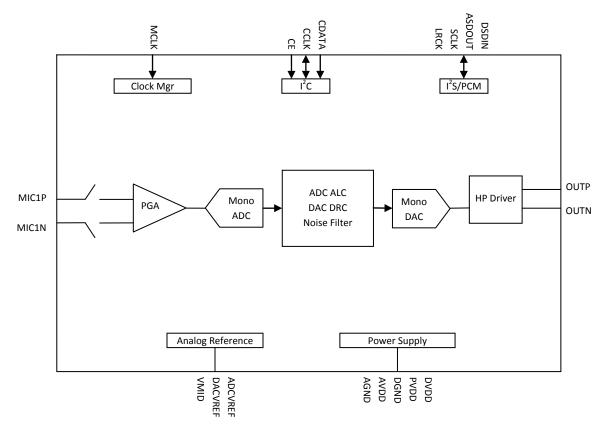
APPLICATIONS

- Automotive
- Phone
- Toy
- 2-way radio
- Dash cam
- IP Camera
- DVR, NVR
- Surveillance

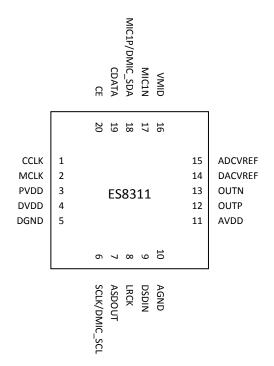
ORDERING INFORMATION

ES8311 -40°C ~ +105°C QFN-20

1. BLOCK DIAGRAM

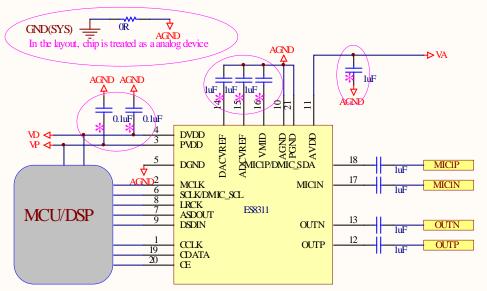


2. PIN OUT AND DESCRIPTION



Pin Name	Pin number	Input or Output	Pin Description
CCLK, CDATA, CE	1, 19, 20	I, I/O, I	I ² C clock, data, address
MCLK	2	I	Master clock
SCLK/DMIC_SCL	6	I/O	Serial data bit clock/DMIC bit clock
LRCK	8	I/O	Serial data left and right channel frame clock
ASDOUT	7	0	ADC serial data output
DSDIN	9	1	DAC serial data input
MIC1P/DMIC_SDA	18		Mic input
MIC1N	17	1	Michiput
OUTP, OUTN	12, 13	0	Differential analog output
PVDD	3	Analog	Power supply for the digital input and output
DVDD, DGND	4, 5	Analog	Digital power supply
AVDD, AGND	11, 10	Analog	Analog power supply
VMID	16	Analog	Filtering capacitor connection
ADCVREF, DACVREF	15, 14	Analog	Filtering capacitor connection

3. TYPICAL APPLICATION CIRCUIT



For the best performance, decoupling and filtering capacitors should be located as close to the device package as possible * Additional paralle capacitors(typically 0.1 μ F) can be used, larger value capacitors(typically 10 μ F) would also help

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4. CLOCK MODES AND SAMPLING FREQUENCIES

The device supports standard audio clocks (64F, 128Fs, 256Fs, 384Fs, 512Fs, etc), USB clocks (12/24 MHz), and some common non standard audio clocks (16 MHz, 25 MHz, 26 MHz, etc).

According to the serial audio data sampling frequency (Fs), the device can work in two speed modes: single speed mode or double speed mode. In single speed mode, Fs normally ranges from 8 kHz to 48 kHz, and in double speed mode, Fs normally range from 64 kHz to 96 kHz.

The device can work either in master clock mode or slave clock mode. In slave mode, LRCK and SCLK are supplied externally, and LRCK and SCLK must be synchronously derived from the system clock with specific rates. In master mode, LRCK and SCLK are derived internally from device master clock.

5. MICRO-CONTROLLER CONFIGURATION INTERFACE

The device supports standard I²C micro-controller configuration interface. External microcontroller can completely configure the device through writing to internal configuration registers.

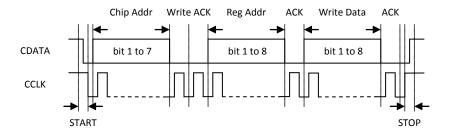
I²C interface is a bi-directional serial bus that uses a serial data line (CDATA) and a serial clock line (CCLK) for data transfer. The timing diagram for data transfer of this interface is given in Figure 1a and Figure 1b. Data are transmitted synchronously to CCLK clock on the CDATA line on a byte-by-byte basis. Each bit in a byte is sampled during CCLK high with MSB bit being transmitted firstly. Each transferred byte is followed by an acknowledge bit from receiver to pull the CDATA low. The transfer rate of this interface can be up to 400 kbps.

A master controller initiates the transmission by sending a "start" signal, which is defined as a high-to-low transition at CDATA while CCLK is high. The first byte transferred is the slave address. It is a seven-bit chip address followed by a RW bit. The chip address must be 0011 00x, where x equals CE. The RW bit indicates the slave data transfer direction. Once an acknowledge bit is received, the data transfer starts to proceed on a byte-by-byte basis in the direction specified by the RW bit. The master can terminate the communication by generating a "stop" signal, which is defined as a low-to-high transition at CDATA while CCLK is high.

In I²C interface mode, the registers can be written and read. The formats of "write" and "read" instructions are shown in Table 1 and Table 2. Please note that, to read data from a register, you must set R/W bit to 0 to access the register address and then set R/W to 1 to read data from the register.

	Chip Address	R/W		Register Address		Data to be written		
start	0011 00 CE	0	ACK	RAM	ACK	DATA	ACK	Stop

Table 1 Write Data to Register in I²C Interface Mode



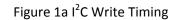


Table 2 Read Data from Register in I²C Interface Mode

	Chip Address	R/W		Register Address		
Start	0011 00 CE	0	ACK	RAM	ACK	
	Chip Address	R/W		Data to be read		
Start	0011 00 CE	1	ACK	Data	NACK	Stop

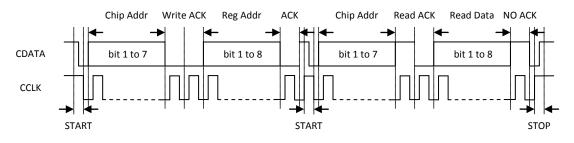
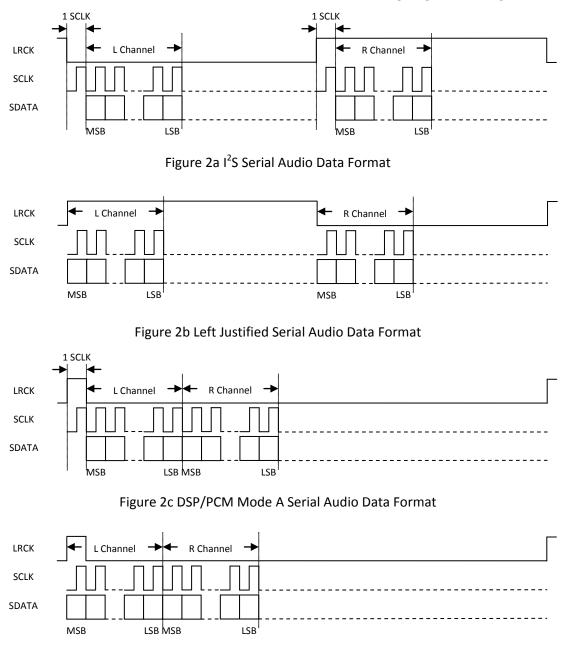
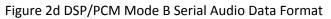


Figure 1b I²C Read Timing

6. DIGITAL AUDIO INTERFACE

The device provides many formats of serial audio data interface to the input of the DAC or output from the ADC through LRCK, SCLK and DSDIN or ASDOUT pins. These formats are I²S, left justified, right justified and DSP/PCM. DAC input DSDIN is sampled by the device on the rising edge of SCLK. ADC data is out at ASDOUT on the falling edge of SCLK. The relationship of SDATA (DSIN/ASDOUT), SCLK and LRCK with these formats are shown through Figure 2a to Figure 2d.





7. ELECTRICAL CHARACTERISTICS

ABSOLUTE MAXIMUM RATINGS

Continuous operation at or beyond these conditions may permanently damage the device.

PARAMETER	MIN	MAX
Analog Supply Voltage Level	-0.3V	+3.6V
Digital Supply Voltage Level	-0.3V	+3.6V
Analog Input Voltage Range	AGND-0.3V	AVDD+0.3V
Digital Input Voltage Range	DGND-0.3V	PVDD+0.3V
Operating Temperature Range	-40°C	+105°C
Storage Temperature	-65°C	+150°C

RECOMMENDED OPERATING CONDITIONS

PARAMETER	MIN	ТҮР	MAX	UNIT
DVDD	1.6	3.3	3.6	V
PVDD	1.6	3.3	3.6	V
AVDD	1.7	3.3	3.6	V

ADC ANALOG AND FILTER CHARACTERISTICS AND SPECIFICATIONS

Test conditions are as the following unless otherwise specify: AVDD=3.3V, DVDD=3.3V, AGND=0V, DGND=0V, Ambient temperature=25°C, Fs=48 KHz, MCLK/LRCK=256.

PARAMETER	MIN	ТҮР	MAX	UNIT
ADC Performance	·	·	·	
Signal to Noise ratio (A-weigh)	95	100	102	dB
THD+N	-95	-93	-85	dB
Gain Error			±5	%
Filter Frequency Response – Single Sp	eed			
Passband	0		0.4535	Fs
Stopband	0.5465			Fs
Passband Ripple			±0.05	dB
Stopband Attenuation	70			dB
Filter Frequency Response – Double S	speed			
Passband	0		0.4167	Fs
Stopband	0.5833			Fs
Passband Ripple			±0.005	dB
Stopband Attenuation	70			dB
Analog Input				
Full Scale Input Level		AVDD/3.3		Vrms
Input Impedance		6		ΚΩ

DAC ANALOG AND FILTER CHARACTERISTICS AND SPECIFICATIONS

Test conditions are as the following unless otherwise specify: AVDD=3.3V, DVDD=3.3V, AGND=0V, DGND=0V, Ambient temperature=25°C, Fs=48 KHz, MCLK/LRCK=256.

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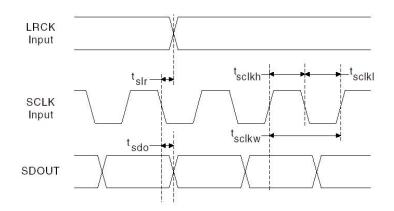
PARAMETER	MIN	ТҮР	MAX	UNIT
DAC Performance				
Signal to Noise ratio (A-weigh)	100	110	115	dB
THD+N	-85	-80	-75	dB
Gain Error			±5	%
Filter Frequency Response – Single Spee	ed			
Passband	0		0.4535	Fs
Stopband	0.5465			Fs
Passband Ripple			±0.05	dB
Stopband Attenuation	53			dB
Filter Frequency Response – Double Spe	eed			
Passband	0		0.4167	Fs
Stopband	0.5833			Fs
Passband Ripple			±0.005	dB
Stopband Attenuation	56			dB
Analog Output				
Full Scale Output Level		AVDD/3.3		Vrms

DC CHARACTERISTICS

PARAMETER	MIN	ТҮР	MAX	UNIT
Normal Operation Mode				
DVDD=1.8V, PVDD=1.8V, AVDD=3.3V		8		mA
Power Down Mode				
DVDD=1.8V, PVDD=1.8V, AVDD=3.3V		0		uA
Digital Voltage Level				
Input High-level Voltage	0.7*PVDD			V
Input Low-level Voltage			0.5	V
Output High-level Voltage		PVDD		V
Output Low-level Voltage		0		V

SERIAL AUDIO PORT SWITCHING SPECIFICATIONS

PARAMETER	Symbol	MIN	MAX	UNIT
MCLK frequency			51.2	MHz
MCLK duty cycle		40	60	%
LRCK frequency			200	KHz
LRCK duty cycle		40	60	%
SCLK frequency			26	MHz
SCLK pulse width low	T _{SCLKL}	15		ns
SCLK Pulse width high	T _{SCLKH}	15		ns
SCLK falling to LRCK edge	T _{SLR}	-10	10	ns
SCLK falling to SDOUT valid	T _{SDO}	11		ns





I²C SWITCHING SPECIFICATIONS

PARAMETER	Symbol	MIN	MAX	UNIT
CCLK Clock Frequency	F _{CCLK}		400	KHz
Bus Free Time Between Transmissions	T _{TWID}	1.3		us
Start Condition Hold Time	T _{TWSTH}	0.6		us
Clock Low time	T _{TWCL}	1.3		us
Clock High Time	T _{TWCH}	0.4		us
Setup Time for Repeated Start Condition	T _{TWSTS}	0.6		us
CDATA Hold Time from CCLK Falling	T _{TWDH}		900	ns
CDATA Setup time to CCLK Rising	T _{TWDS}	100		ns
Rise Time of CCLK	T _{TWR}		300	ns
Fall Time CCLK	T _{TWF}		300	ns

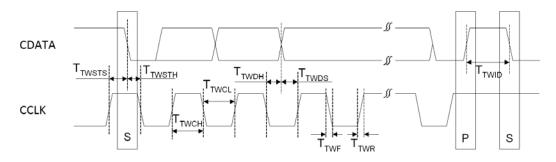
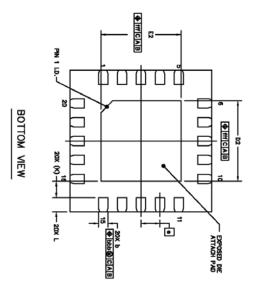
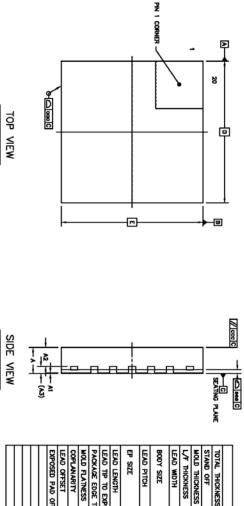


Figure 4 I²C Timing

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8. PACKAGE





		TORMAS	MIN	MON	MYX
ICKNESS		>	0.5	0.55	0.6
-		A1	0	0.02	0.05
XNESS		A2	-	0.4	
NESS		λJ		0,152 REF	
Ŧ		ь	0.15	0.2	0.25
	×	D		3 BSC	
	۲	E		3 BSC	
¥				0.4 BSC	
	×	D2	1.6	1.7	1.8
	۲	E2	1.6	1.7	1.8
GTH		r	0.2	0.3	0.4
TO EXPOSED PAD EDGE	AD EDGE	*		0.35 REF	
EDGE TOLERANCE	Ê	000		0.1	
INESS		000		0,1	
TT		900		0.08	
SET		ьрр		0.1	
PAD OFFSET		fff		0.1	

9. CORPORATE INFORMATION

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